

# NTC thermistors for temperature measurement

Probe assemblies

Series/Type: B57703 Date: March 2006

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#### Probe assemblies

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# Applications

Surface temperature measurement, e.g. on housings and pipes

# Features

- High accuracy
- Easy mounting
- Good thermal coupling through metal tag
- Thermistor encapsulated in metal-tag case
- PTFE-insulated leads of silver-plated nickel wire, AWG 30
- UL approval (E69802)

## Options

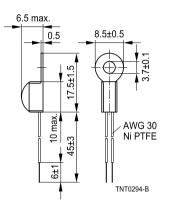
Alternative resistance ratings, rated temperatures, resistance tolerances and lead lengths available on request

# **Delivery mode**

Bulk

# General technical data

# Dimensional drawing



Dimensions in mm Approx. weight 0.8 g

Climatic category	(IEC 60068-1)		55/125/56	
Max. power	(at 25 °C)	P <sub>25</sub>	150	mW
Resistance tolerance		$\Delta R_{R}/R_{R}$	±2	%
Rated temperature		T <sub>R</sub>	25	°C
Dissipation factor	(in air)	$\delta_{th}^{(1)}$	approx. 3	mW/K
Thermal cooling time constant	(in air)	$\tau_c^{(1)}$	approx. 50	s
Heat capacity		$C_{th}^{1)}$	approx. 150	mJ/K
Test voltage	(t = 1 s)	V <sub>test</sub>	1	kVAC

#### Electrical specification and ordering codes

R <sub>25</sub>	No. of R/T	B <sub>25/100</sub>	Ordering code
Ω	characteristic	К	
5 k	8016	3988 ±1%	B57703M0502G040
10 k	8016	3988 ±1%	B57703M0103G040
30 k	8018	3964 ±1%	B57703M0303G040

1) Depends on mounting situation.



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# Reliability data

Test	Standard	Test conditions	$\Delta R_{25}/R_{25}$ (typical)	Remarks
Storage in dry heat	IEC 60068-2-2	Storage at upper category temperature T: 125 °C t: 1000 h	< 1%	No visible damage
Storage in damp heat, steady state	IEC 60068-2-78	Temperature of air: 40 °C Relative humidity of air: 93% Duration: 56 days	< 1%	No visible damage
Rapid temperature cycling	IEC 60068-2-14	Lower test temperature: -55 °C Upper test temperature: 125 °C Number of cycles: 10	< 0.5%	No visible damage
Endurance		P <sub>max</sub> : 150 mW t: 1000 h	< 1%	No visible damage
Long-term stability (empirical value)		Temperature: 70 °C t: 10000 h	< 2%	No visible damage

# Probe assemblies

# **R/T characteristics**

	B57703M0502G040					
R/T No.	8016					
T (°C)	$B_{25/100} = 3988 \text{ K}, \ R_{25} = 5000 \ \Omega, \ T_R = 25 \ ^\circ\text{C}, \ \Delta R_R/R_R = \pm 2\%$					
	$R_{nom}[\Omega]$	$R_{min}[\Omega]$	$R_{\max}[\Omega]$	$\Delta R_R/R_R[\pm\%]$	$\Delta T[\pm^{\circ}C]$	α (%/K)
-55.0	481520	448030	515020	7.0	0.9	7.4
-50.0	335050	313120	356980	6.5	0.9	7.1
-45.0	235840	221330	250360	6.2	0.9	6.9
-40.0	168250	158530	177970	5.8	0.9	6.7
-35.0	121300	114720	127870	5.4	0.8	6.4
-30.0	88500	84008	92992	5.1	0.8	6.2
-25.0	65185	62092	68278	4.7	0.8	6.0
-20.0	48535	46386	50684	4.4	0.8	5.8
-15.0	36465	34961	37968	4.1	0.7	5.6
-10.0	27665	26606	28724	3.8	0.7	5.4
-5.0	21158	20407	21908	3.5	0.7	5.3
0.0	16325	15790	16860	3.3	0.6	5.1
5.0	12694	12311	13076	3.0	0.6	5.0
10.0	9950	9676	10224	2.8	0.6	4.8
15.0	7854	7656	8051	2.5	0.5	4.7
20.0	6245	6103	6387	2.3	0.5	4.5
25.0	5000	4900	5100	2.0	0.5	4.4
30.0	4029	3937	4120	2.3	0.5	4.3
35.0	3266	3185	3347	2.5	0.6	4.1
40.0	2664	2592	2735	2.7	0.7	4.0
45.0	2184	2121	2247	2.9	0.7	3.9
50.0	1802	1746	1857	3.1	0.8	3.8
55.0	1493	1444	1542	3.3	0.9	3.7
60.0	1244	1201	1287	3.5	1.0	3.6
65.0	1042	1004	1079	3.6	1.0	3.5
70.0	876.0	842.7	909.3	3.8	1.1	3.4
75.0	740.7	711.3	770.1	4.0	1.2	3.3
80.0	629.0	603.0	655.0	4.1	1.3	3.2
85.0	536.2	513.2	559.2	4.3	1.4	3.2
90.0	458.8	438.5	479.2	4.4	1.4	3.1
95.0	394.3	376.1	412.4	4.6	1.5	3.0
100.0	340.0	323.9	356.1	4.7	1.6	2.9
105.0	294.3	279.9	308.7	4.9	1.7	2.9
110.0	255.6	242.8	268.4	5.0	1.8	2.8
115.0	222.7	211.2	234.2	5.2	1.9	2.7
120.0	194.7	184.4	204.9	5.3	2.0	2.7
125.0	170.9	161.6	180.1	5.4	2.1	2.6

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360.2

5.4

2.1

2.6

341.7

323.2

125.0

# Temperature measurement

## **Probe assemblies**

	B57703M0103G040						
R/T No.	. 8016						
T (°C)	$B_{25/100} = 3988 \text{ K}, \ R_{25} = 10000 \ \Omega, \ T_R = 25 \ ^\circ\text{C}, \ \Delta R_R/R_R = \pm 2\%$						
	$R_{nom}[\Omega]$	$R_{\min}[\Omega]$	$R_{max}[\Omega]$	$\Delta R_R/R_R[\pm\%]$	$\Delta T[\pm^{\circ}C]$	α (%/K)	
-55.0 -50.0 -45.0 -40.0 -35.0	963050 670100 471690 336500 242590	896070 626240 442660 317050 229440	1030000 713960 500710 355950 255740	7.0 6.5 6.2 5.8 5.4	0.9 0.9 0.9 0.9 0.9 0.8	7.4 7.1 6.9 6.7 6.4	
-30.0 -25.0 -20.0 -15.0 -10.0	177000 130370 97070 72929 55330	168020 124180 92772 69923 53211	185980 136560 101370 75936 57449	5.1 4.7 4.4 4.1 3.8	0.8 0.8 0.8 0.7 0.7	6.2 6.0 5.8 5.6 5.4	
-5.0 0.0 5.0 10.0 15.0	42315 32650 25388 19900 15708	40814 31581 24623 19351 15313	43816 33719 26152 20449 16103	3.5 3.3 3.0 2.8 2.5	0.7 0.6 0.6 0.6 0.5	5.3 5.1 5.0 4.8 4.7	
20.0 <b>25.0</b> 30.0 35.0 40.0	12490 <b>10000</b> 8057 6531 5327	12205 <b>9800</b> 7874 6369 5184	12775 <b>10200</b> 8240 6694 5470	2.3 <b>2.0</b> 2.3 2.5 2.7	0.5 <b>0.5</b> 0.6 0.7	4.5 <b>4.4</b> 4.3 4.1 4.0	
45.0 50.0 55.0 60.0 65.0	4369 3603 2986 2488 2083	4242 3492 2888 2402 2007	4495 3714 3084 2574 2159	2.9 3.1 3.3 3.5 3.6	0.7 0.8 0.9 1.0 1.0	3.9 3.8 3.7 3.6 3.5	
70.0 75.0 80.0 85.0 90.0	1752 1481 1258 1072 917.7	1685 1423 1206 1026 876.9	1819 1540 1310 1118 958.5	3.8 4.0 4.1 4.3 4.4	1.1 1.2 1.3 1.4 1.4	3.4 3.3 3.2 3.2 3.1	
95.0 100.0 105.0 110.0 115.0	788.5 680.0 588.6 511.2 445.4	752.3 647.8 559.9 485.6 422.5	824.7 712.2 617.3 536.8 468.4	4.6 4.7 4.9 5.0 5.2	1.5 1.6 1.7 1.8 1.9	3.0 2.9 2.9 2.8 2.7	
120.0	389.3	368.7	409.9	5.3	2.0	2.7	

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1633

1424

1245

1092

5.0

5.1

5.3

5.4

1.8

1.9

2.0

2.1

2.8

2.7

2.7

2.6

1555

1354

1182

1036

1478

1285

1120

980.0

110.0

115.0

120.0

125.0

# Temperature measurement

#### **Probe assemblies**

	B57703M0303G040					
R/T No.	8018					
T (°C)	$B_{25/100} = 3964 \text{ K}, \ R_{25} = 30000 \ \Omega, \ T_R = 25 \ ^\circ\text{C}, \ \Delta R_R/R_R = \pm 2\%$					
	$R_{nom}[\Omega]$	$R_{min}[\Omega]$	$R_{\max}[\Omega]$	$\Delta R_{\rm R}/R_{\rm R}[\pm\%]$	$\Delta T[\pm^{\circ}C]$	α (%/K)
-55.0	2472200	2301000	2643500	6.9	1.0	7.0
-50.0	1750300	1636200	1864400	6.5	1.0	6.8
-45.0	1253200	1176400	1330100	6.1	0.9	6.6
-40.0	907060	854840	959270	5.8	0.9	6.4
-35.0	663280	627460	699090	5.4	0.9	6.2
-30.0	489810	465040	514580	5.1	0.8	6.0
-25.0	365130	347860	382390	4.7	0.8	5.8
-20.0	274640	262520	286770	4.4	0.8	5.6
-15.0	208370	199810	216940	4.1	0.8	5.4
-10.0	159410	153320	165490	3.8	0.7	5.3
-5.0	122920	118570	127260	3.5	0.7	5.1
0.0	95501	92381	98621	3.3	0.7	5.0
5.0	74745	72498	76991	3.0	0.6	4.8
10.0	58911	57288	60533	2.8	0.6	4.7
15.0	46745	45571	47919	2.5	0.6	4.6
20.0	37332	36482	38182	2.3	0.5	4.4
25.0	30000	29400	30600	2.0	0.5	4.3
30.0	24253	23702	24803	2.3	0.5	4.2
35.0	19720	19230	20209	2.5	0.6	4.1
40.0	16123	15690	16556	2.7	0.7	4.0
45.0	13252	12870	13635	2.9	0.7	3.9
50.0	10949	10612	11286	3.1	0.8	3.8
55.0	9091	8794	9388	3.3	0.9	3.7
60.0	7584	7323	7846	3.4	1.0	3.6
65.0	6356	6126	6586	3.6	1.0	3.5
70.0	5351	5148	5554	3.8	1.1	3.4
75.0	4524	4344	4703	4.0	1.2	3.3
80.0	3840	3682	3998	4.1	1.3	3.2
85.0	3273	3133	3413	4.3	1.4	3.2
90.0	2800	2676	2924	4.4	1.4	3.1
95.0	2405	2295	2515	4.6	1.5	3.0
100.0	2073	1975	2170	4.7	1.6	2.9
105.0	1792	1705	1880	4.9	1.7	2.9



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## Probe assemblies

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# **Cautions and warnings**

#### General

See "Important notes" at the end of this document.

# Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Do not store SMDs where they are exposed to heat or direct sunlight. Otherwise, the packing material may be deformed or SMDs may stick together, causing problems during mounting.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environments like corrosive gases (SOx, Cl etc).
- After opening the factory seals, such as polyvinyl-sealed packages, use the SMDs as soon as possible.
- Solder thermistors after shipment from EPCOS within the time specified: SMDs: 12 months
  Leaded components: 24 months

#### Handling

- NTC thermistors must not be dropped. Chip-offs must not be caused during handling of NTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

#### Soldering

- Use resin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.

#### Mounting

- When NTC thermistors are encapsulated with sealing material or overmolded with plastic material, the precautions given in chapter "Mounting instructions", "Sealing, potting and overmolding" must be observed.
- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housings used for assembly with thermistor have to be clean before mounting.
- During operation, the thermistor's surface temperature can be very high (ICL). Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling ot the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of the thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Make sure that thermistors (ICLs) are adequately ventilated to avoid overheating.
- Avoid contamination of thermistor surface during processing.



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# Operation

- Use thermistors only within the specified operating temperature range.
- Use thermistors only within the specified voltage and current ranges (ICLs).
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions.
- Contact of NTC thermistors with any liquids and solvents should be prevented. It must be ensured that no water enters the NTC thermistor (e.g. through plug terminals). For measurement purposes (checking the specified resistance vs. temperature), the component must not be immersed in water but in suitable liquids (e.g. Galden).
- Avoid dewing and condensation.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by malfunction (e.g. use VDR for limitation of overvoltage condition).

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